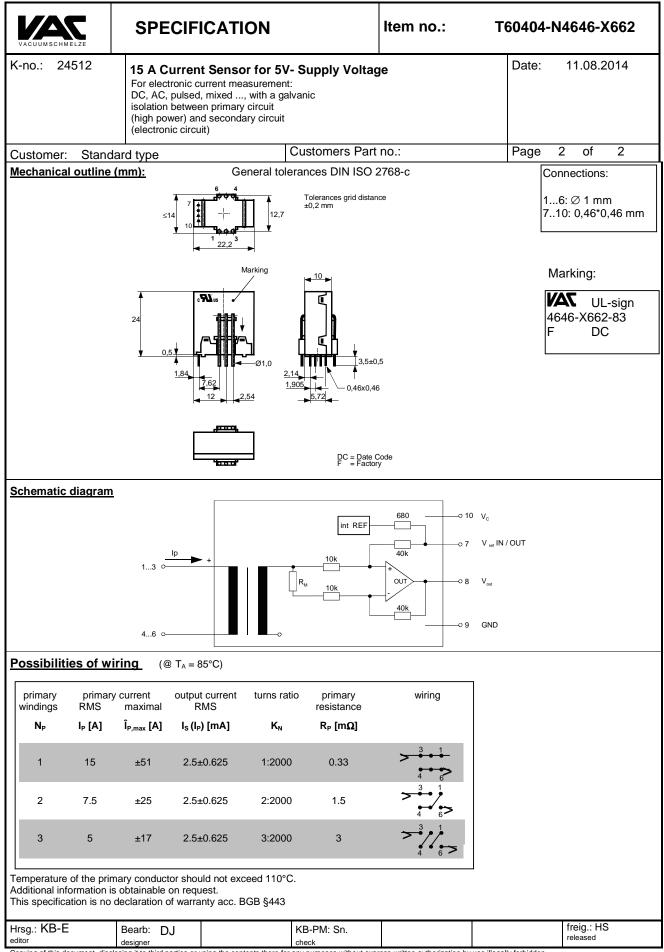
VACUUMSCHMELZE	SPECIFICATION	Item no.:	T60404-N46	46-X662
K-no.: 24512	<b>15 A Current Sensor for 5V- Suppl</b> For electronic current measurement: DC, AC, pulsed, mixed, with a galvanic isolation between primary circuit (high power) and secondary circuit (electronic circuit)	ly Voltage	Date: 11	.08.2014
Customer: Stan	dard type Custom	ners Part no.:	Page 1	of 2
Description Closed loop (comp Current Sensor with field probe Printed circuit board Casing and materia	Characteristics           ensation)         • Excellent accuracy           n magnetic         • Very low offset current           • Very low temperature depend current drift	applications: • AC variable drives • Static conv. • Battery sup • Switched M • Power Sup	stationary operation e speed drives and s erters for DC motor plied applications lode Power Supplie plies for welding applies	servo motor drives s (SMPS) plications
Electrical data – Ra	atings			
I <sub>PN</sub>	Primary nominal r.m.s. current	15		А
V <sub>out</sub>	Output voltage $@$ I <sub>P</sub>		± (0.625*I <sub>P</sub> /I <sub>PN</sub> )	V
V <sub>out</sub>	Output voltage @ $I_P$ =0, $T_A$ =25°C		± 0.00221	V
V <sub>Ref</sub>	External Reference voltage range	V RU	04	V
V Rei	Internal Reference voltage		$2.5 \pm 0.005$	v
K <sub>N</sub>	Turns ratio	1:	3 : 2000	-
Accuracy – Dynam	nic performance data			
		min. typ.	max.	Unit
I <sub>P,max</sub>	Max. measuring range	±51	0.7	0/
Х	Accuracy @ I <sub>PN</sub> , T <sub>A</sub> = 25°C		0.7	%
εL			0.1	%
V <sub>out</sub> - V <sub>Ref</sub>	Offset voltage @ $I_P=0$ , $T_A=25^{\circ}C$		±2.21	mV
$\Delta V_o / V_{Ref} / \Delta T$	Temperature drift of V <sub>out</sub> @ I <sub>P</sub> =0, V <sub>Ref</sub> =2,5		20	ppm/°C
tr	Response time @ 90% von I <sub>PN</sub>	300		ns
· ·· ·	Delay time at di/dt = 100 A/µs	200		ns
∆t (I <sub>P,max</sub> )		DC 200		
f	Frequency bandwidth	DC200		kHz
f		DC200 min. typ.	max.	kHz Unit
f			<mark>max.</mark> +85	
f General data	Frequency bandwidth	min. typ.		Unit
f General data T <sub>A</sub>	Frequency bandwidth Ambient operating temperature	<mark>min. typ.</mark> -40	+85	<mark>Unit</mark> ℃
f <u>General data</u> T <sub>A</sub> Ts	Frequency bandwidth Ambient operating temperature Ambient storage temperature	<mark>min. typ.</mark> -40 -40	+85	<mark>Unit</mark> ℃ ℃
f General data T <sub>A</sub> T <sub>S</sub> m	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass	min. typ. -40 -40 12	+85 +85	<mark>Unit</mark> ℃ ℃ g
f General data T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tested Reinforced insulation, Insulation material	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         group 1, Pollution degree 2	+85 +85 5.25	Unit °C °C g V mA
f General data T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub> I <sub>C</sub> S <sub>clear</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad)	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         12           group 1, Pollution degree 2         7,4	+85 +85 5.25	Unit °C °C g V mA 17 – 10) mm
f <u>General data</u> T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub> I <sub>C</sub> <u>Sclear</u> S <sub>creep</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad)	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-9         group 1, Pollution degree 2           7,4         8,0	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin	Unit °C °C g V mA 7 – 10) mm mm
f <u>General data</u> T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub> I <sub>C</sub> S <sub>clear</sub> S <sub>creep</sub> V <sub>sys</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage overvoltage category 3	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         15           group 1, Pollution degree 2         7,4           8,0         RMS	+85 +85 5.25	Unit °C °C g V mA 17 – 10) mm
f General data T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub> I <sub>C</sub> Sclear Screep V <sub>sys</sub> V <sub>work</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage volta	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         15           group 1, Pollution degree 2         7,4           8,0         RMS	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300 650	Unit °C °C g V mA 7 – 10) mm mm V
f <u>General data</u> T <sub>A</sub> T <sub>S</sub> m V <sub>C</sub> I <sub>C</sub> S <sub>clear</sub> S <sub>creep</sub> V <sub>sys</sub>	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage volta	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         15           group 1, Pollution degree 2         7,4           8,0         RMS           800-5-1)         800-5-1)	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300	Unit °C °C g V mA 7 – 10) mm mm V
f General data TA Ts m Vc Ic Sclear Screep Vsys Vwork UPD	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage volta	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         15           group 1, Pollution degree 2         7,4           8,0         RMS           800-5-1)         RMS	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300 650	Unit °C °C g V mA 0 7 – 10) mm mm V
f <u>General data</u> TA Ts m Vc Ic S <sub>clear</sub> S <sub>creep</sub> V <sub>sys</sub> V <sub>work</sub> U <sub>PD</sub> Max. potential di	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tested Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage voervoltage category 3 Working voltage (tabel 7 acc. to EN618 overvoltage category 2 Rated discharge voltage ifference acc. to UL 508	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-3         15           group 1, Pollution degree 2         7,4           8,0         RMS           800-5-1)         RMS           peak value         12	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300 650 1320	Unit °C °C g V mA 7 – 10) mm mm V V V
f <u>General data</u> TA Ts m Vc Ic S <sub>clear</sub> S <sub>creep</sub> V <sub>sys</sub> V <sub>work</sub> U <sub>PD</sub> Max. potential di	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage voltage voltage overvoltage category 3 Working voltage Rated discharge voltage	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-1         group 1, Pollution degree 2           7,4         8,0           RMS         800-5-1)           RMS         peak value           RMS         RMS	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300 650 1320 600	Unit °C °C g V mA 7 – 10) mm mm V V V
f <u>General data</u> TA Ts m Vc Ic Sclear Screep Vsys Vwork UPD Max. potential di Date Name Is	Frequency bandwidth Ambient operating temperature Ambient storage temperature Mass Supply voltage Current consumption Constructed and manufactored and tester Reinforced insulation, Insulation material Clearance (component without solder pad) Creepage (component without solder pad) System voltage voervoltage category 3 Working voltage (tabel 7 acc. to EN618 overvoltage category 2 Rated discharge voltage ifference acc. to UL 508	min.         typ.           -40         -40           -40         12           4.75         5           15         15           d in accordance with EN 61800-1         group 1, Pollution degree 2           7,4         8,0           RMS         800-5-1)           RMS         peak value           RMS         RMS	+85 +85 5.25 5-1 (Pin 1 - 6 to Pin 300 650 1320 600	Unit °C °C g V mA 7 – 10) mm mm V V V

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Z-No.: 24512		1		00404-1140-	46-X662
	<b>15 A Current Sensor for 5V-Supply V</b> For the electronic measurement of currents: DC, AC, pulsed, mixed, with a galvanic Isolation between the primary circuit (high power) and the secondary circuit	oltage		Date:	11.08.2014
Customer:	Customers F	Part No.:		Page 1	of 2
lectrical Data					
		min.	typ.	max.	Unit
V <sub>Ctot</sub>	Maximum supply voltage (without function)	1 E 100 A	. 1 * 12 /	7	V
	Supply Current with primary current Short circuit output current	ISINA	√+lp*K <sub>N</sub> +Vou ±20	t/KL	mA mA
I <sub>out,SC</sub> R <sub>P</sub>	Resistance / primary winding @ $T_A=25^{\circ}C$		±20		mΩ
Rs	Secondary coil resistance $@$ T <sub>A</sub> =85°C		1	67	Ω
R <sub>i.Ref</sub>	Internal resistance of Reference input		670	01	Ω
Ri,(V <sub>out</sub> )	Output resistance of $V_{out}$		0.0	1	Ω
RL	External recommended resistance of Vout	1		•	 kΩ
CL	External recommended resistance of Vout			500	pF
$\Delta X_{Ti} / \Delta T$	Temperature drift of X @ $T_A = -40 \dots +85 \ ^{\circ}C$			40	ppm/K
$\Delta V_0 = \Delta (V_{out} - V_{Ref})$	Sum of any offset drift including:		3.5	10	mV
V <sub>0t</sub>	Longtermdrift of V <sub>0</sub>		2		mV
V <sub>0T</sub>	Temperature drift von V <sub>0</sub> @ $T_A = -40 \dots +85^{\circ}C$		2		mV
V <sub>0H</sub>	Hysteresis of $V_{out} @ I_P=0$ (after an overload of 10	x I <sub>PN</sub> )		3	mV
$\Delta V_0 / \Delta V_C$	Supply voltage rejection ratio			1	mV/V
V <sub>oss</sub>	Offsetripple (with 1 MHz- filter first order)			30	mV
V <sub>OSS</sub>	Offsetripple (with 100 kHz- filter firdt order)		4	8	mV
V <sub>oss</sub>	Offsetripple (with 20 kHz- filter first order)		1.2	2	mV
C <sub>k</sub>	Maximum possible coupling capacity (primary – Mechanical stress according to M3209/3 Settings: 10 – 2000 Hz, 1 min/Octave, 2 hours	- secondary)	5	10 30g	pF
nenaction (Massura	nent after temperature balance of the samples at room	tomporatura)	SC – signific	ant charactorist	ic
		. ,	0		
	M3011/6: Output voltage vs. external referen M3226: Offset voltage	Ce (I <sub>P</sub> =15A, 40-	80HZ)	625±0.7% ± 2.21	mV mV
V <sub>out</sub> -V <sub>Ref</sub> (I <sub>P</sub> =0) (V) V <sub>d</sub> (V)	M3014: Test voltage, rms, 1 s			± 2.21	kV
va (v)	pin 1 – 6 vs. pin 7 – 10			1.5	ĸv
V <sub>e</sub> (AQ	L 1/S4) Partial discharge voltage acc.M302	24 (RMS)		1400	V
	with V <sub>vor</sub> (RMS)			1750	V
<b>vpe Testing</b> (Pin 1 -	- 6 to Pin 7 - 10) standard EN 50178 with insulation material grou	up 1			
V <sub>w</sub>	HV transient test according to M3064 (1,2 $\mu$ s / $\pm$		rm)	8	kV
V <sub>d</sub>	Testing voltage to M3014	00 µ0 wave 10	(5 s)	3	kV
V <sub>d</sub> V <sub>e</sub>	Partial discharge voltage acc.M3024 (RMS)		(00)	1400	V
	with V <sub>vor</sub> (RMS)			1750	V